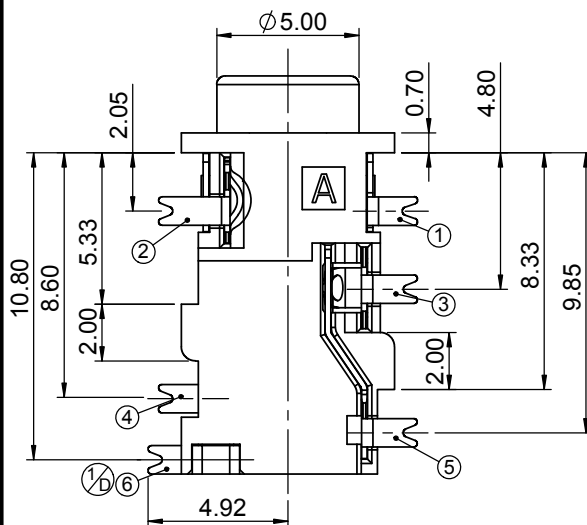
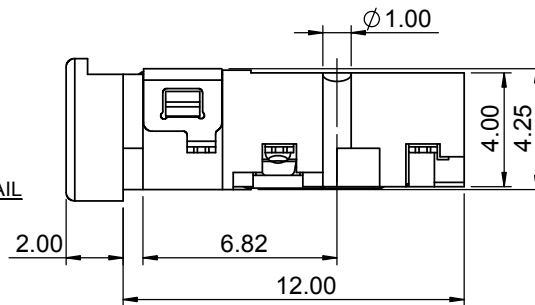
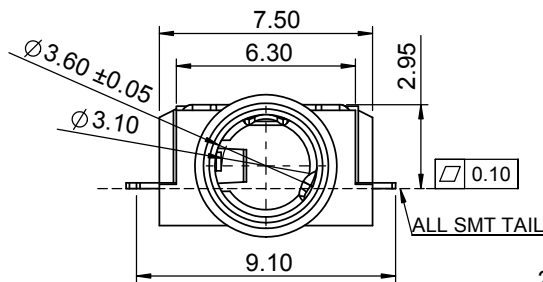
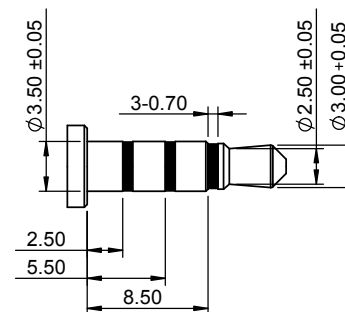
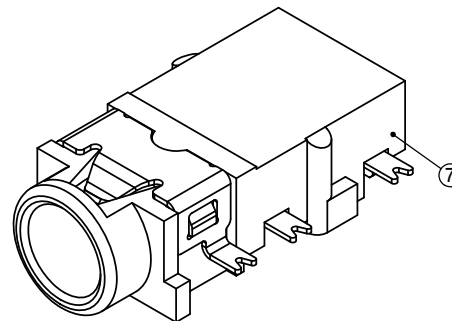


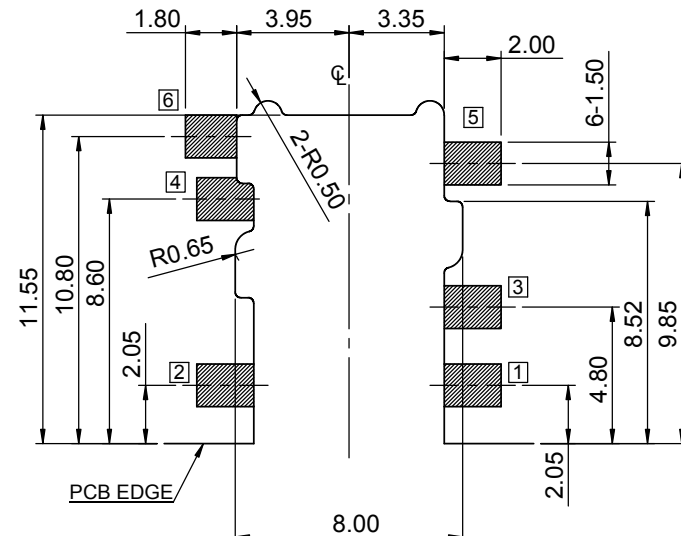


- NOTES:
 1. CONTACT CURRENT RATING: 1A.
 2. CONTACT RESISTANCE: 50 mΩ MAX.;
 3. INSULATION RESISTANCE: 100MΩ MIN.;
 4. DIELECTRIC WITHSTANDING: 500V AC MIN.;
 5. DURABILITY: 5,000 CYCLES MIN.;
 6. CONNECTOR MATING FORCES:
 29.4N (3.00Kgf) MAX.;
 7. CONNECTOR UNMATING FORCES:
 2.94N(0.30Kgf) MIN.;

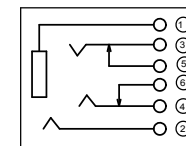
旧料号: PJK-311S-C 改新料号: J303-B06G1-NZL2



Ø3.50mm 4 POLE PLUG
 DETAIL DRAWING(2:1)



RECOMMENDED PCB LAYOUT(TOP VIEW)
 (GENERAL TOLERANCE ±0.05)



SCHEMATIC

7	HOUSING	HIGH TEMP	BLACK	
6	TERMINAL 6	COPPER ALLOY		GOLD PLATED/TIN
5	TERMINAL 5	COPPER ALLOY		GOLD PLATED/TIN
4	TERMINAL 4	COPPER ALLOY		GOLD PLATED/TIN
3	TERMINAL 3	COPPER ALLOY		GOLD PLATED/TIN
2	TERMINAL 2	COPPER ALLOY		GOLD PLATED/TIN
1	TERMINAL 1	COPPER ALLOY		GOLD PLATED/TIN
NO.	DESCRIPTION	MAT.L	COLOR	REMARK

CUSTOMER COPY 东莞市溪榜电子有限公司
 DONG GUAN XI BANG ELECTRONICS CO., LTD.

TITLE:	Ø3.50 mm PHONE JACK CONNECTOR		
PART NO.	J303-B06G1-NZL2(速记码: J303-N		
PRODUCT SPEC.	JH-RD-W06		
D	FILE NAME.	XB-J303-B06G1-NZL2-C	
ING	SCALE	4:1	UNIT:mm A4
			SHEET: 1 of 2

JH2012-049	D	11/26/'12	D1:图面规范化	梁碧华	罗志兵	Angle	±2°	DESIGN	梁碧华	11/26/'12
JH2012-041	C	10/18/'12	C1:图面规范化	彭志况	罗志兵	.X	±0.35	CHECK	谭艳斌	11/26/'12
JH2012-029	B	09/18/'12	B1:变更图面及料号	彭志况	罗志兵	.XX	±0.25			
ECN NO.	REV	DATE	DESCRIPTION	CHANGE	APPRO.	GENERAL TOLERANCE UNLESS OTHERWISE NOTED		APPRO.	罗志兵	11/26/'12